



Features

- Low driver power requirements (TTL/CMOS Compatible)
- High reliability
- Arc-Free with no snubbing circuits
- 3750VRms Input/Output isolation
- Tape & Reel version available

Applications

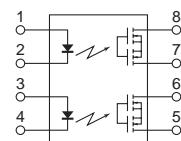
- Telecommunications (PC, Electronic notepad)
- Measuring and Testing equipment
- Industrial control
- Security equipments
- High speed inspection machine



SMD-8

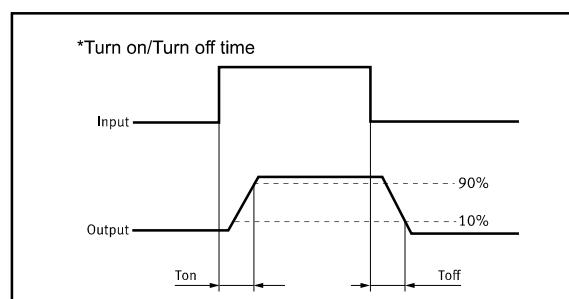


DIP-8



1,3. LED Anode
 2,4. LED Cathode
 5,6. Drain (MOS FET)
 7,8. Drain (MOS FET)

(Unit: mm)



TYPES

Category	Output rating				Packing quantity
	Load voltage	Load current	Part No.	Package	
AC/DC	600V	80mA	GAQW216E	DIP-8	25pcs/Tube
			GAQW216EH	SMD-8	1000pcs/1reel

Absolute Maximum Ratings (Ambient Temperature: 25 °C)

Item		Symbol	Value	Units	Note
Input	Continuous LED Current	I _F	50	mA	
	Peak LED Current	I _{FP}	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	V _R	7	V	
	Input Power Dissipation	P _{In}	75	mW	
Output	Load Voltage	V _L	600	V(AC peak or DC)	
	Load Current	I _L	80	mA	
	Peak Load Current	I _{Peak}	120	mA	100ms(1 pulse)
	Output Power Dissipation	P _{out}	450	mW	
Total Power Dissipation		P _T	500	mW	
I/O Breakdown Voltage		V _{I/O}	3750	Vrms	RH=60%, 1min
Operating Temperature		T _{opr}	-40 to +85	°C	
Storage Temperature		T _{stg}	-40 to +100	°C	
Pin Soldering Temperature		T _{sol}	260	°C	10 sec max.

Electrical Specifications (Ambient Temperature: 25 °C)

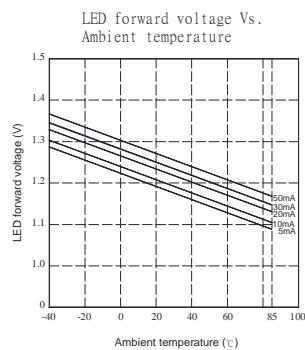
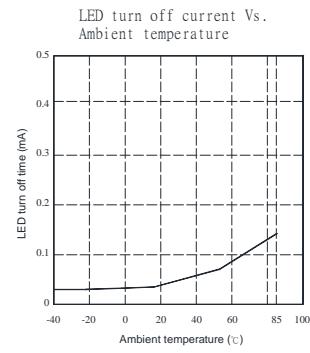
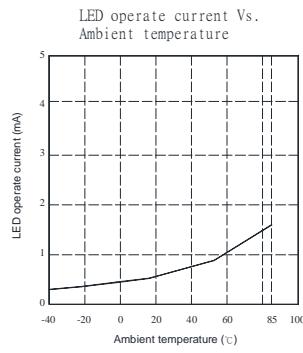
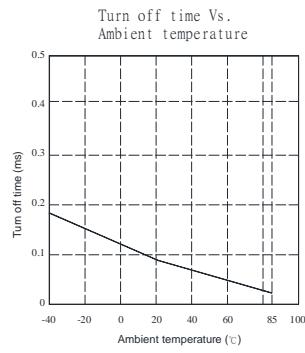
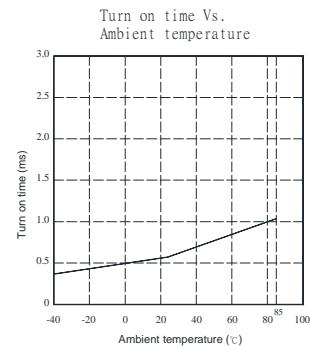
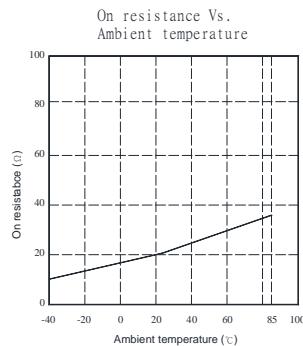
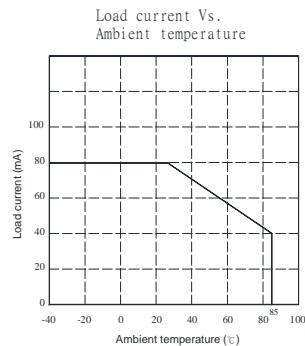
Item		Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	V _F		1.2	1.5	V	I _F =10mA
	Operation LED Current	I _{F on}		0.3	3.0	mA	
	Recovery LED Current	I _{F off}		0.35	0.5	mA	
	Recovery LED Voltage	V _{F off}	0.7			V	
Output	On-Resistance	R _{on}		30	42	Ω	I _F =5mA, I _L =100mA, Time to flow is within 1 sec.
	Off-State Leakage Current	I _{Leak}			1	uA	V _L =Rating
	Output Capacitance	C _{out}		100		pF	V _L =0, f=1MHz
Transmis sion	Turn-On Time	T _{on}		0.2	1.0	ms	I _F =5mA, I _L =100mA,
	Turn-Off Time	T _{off}		0.02	0.2	ms	
Coupled	I/O Isolation Resistance	R _{I/O}	10 ¹⁰			Ω	DC500V
	I/O Capacitance	C _{I/O}		0.8	1.5	pF	f=1MHz

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA.

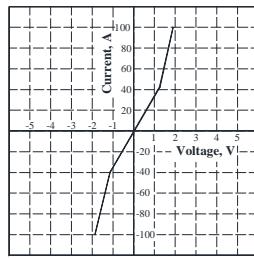
Examples of resistance value to control LED forward current (IF=5mA, INPUT VOLTAGE="E", RESISTORS="R")

"E"=3.3V, "R"=330Ω; "E"=5V, "R"=640Ω; "E"=12V, "R"=1.9KΩ; "E"=15V, "R"=2.5KΩ; "E"=24V, "R"=4.1KΩ;

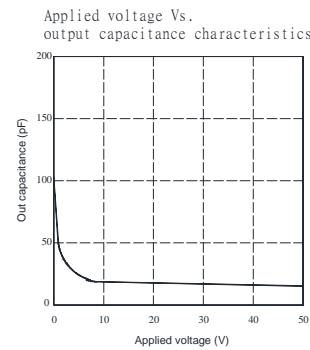
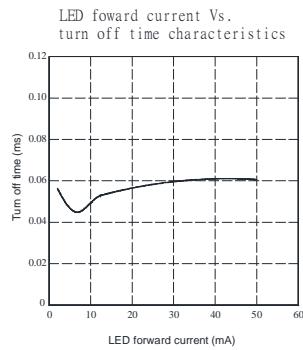
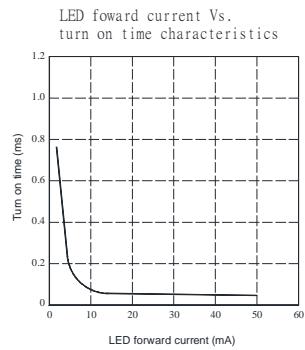
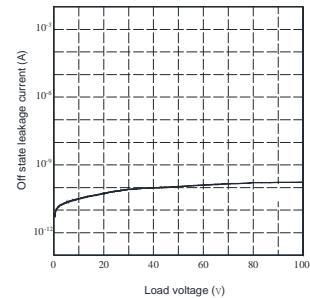
Reference Data



Voltage Vs. current characteristics
of output at MOS portion



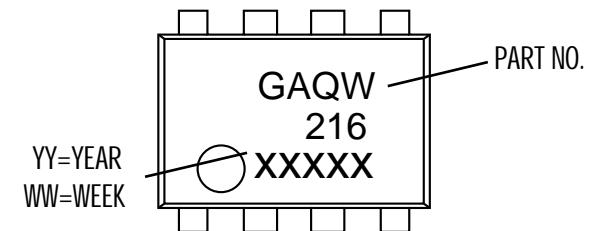
Off state leakage current



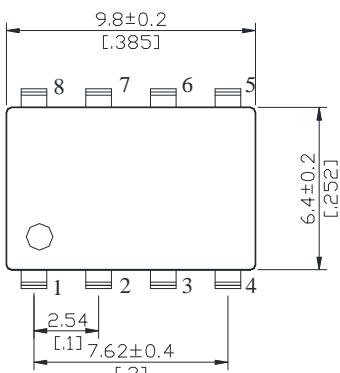
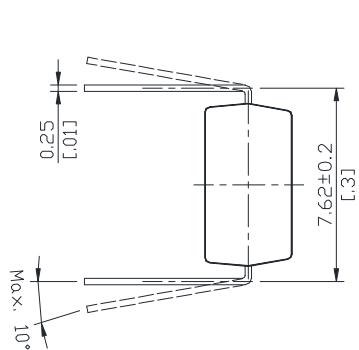
8-DIP

Dimensions

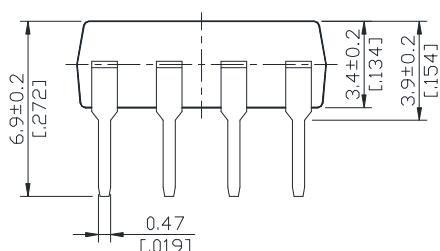
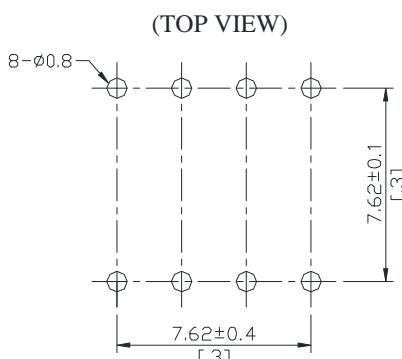
mm inch



Through hole terminal type

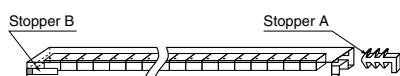


PC board pattern


 Unit : mm inch
 Tolerance: +0.2 -.007

DIP type

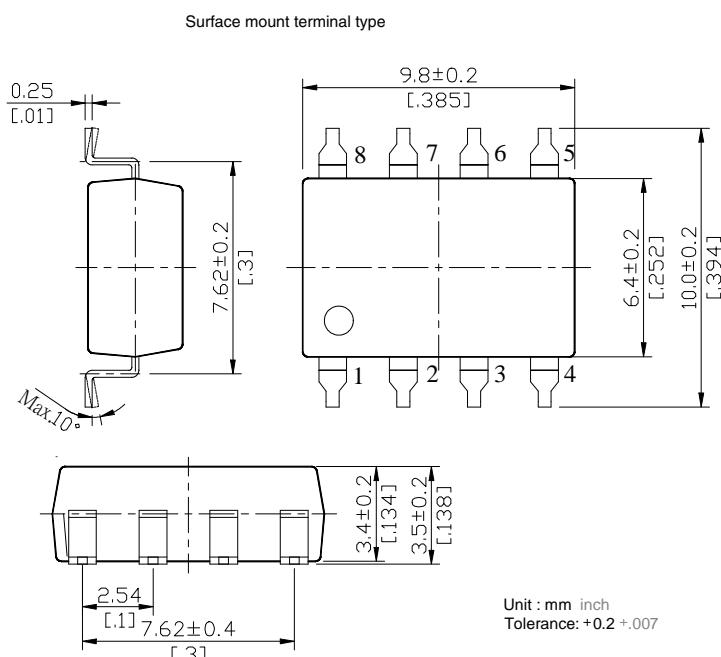
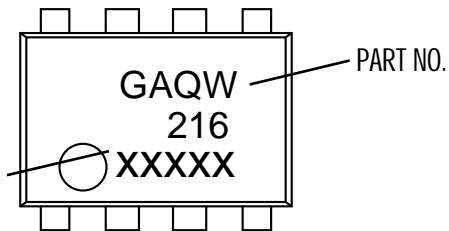
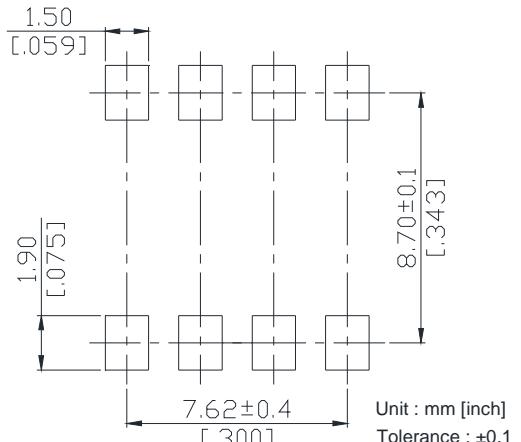
Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.



8-SMD

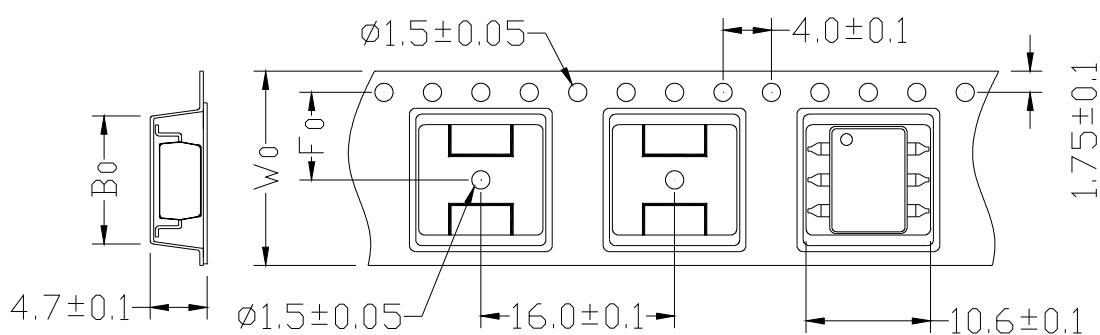
Dimensions

mm inch

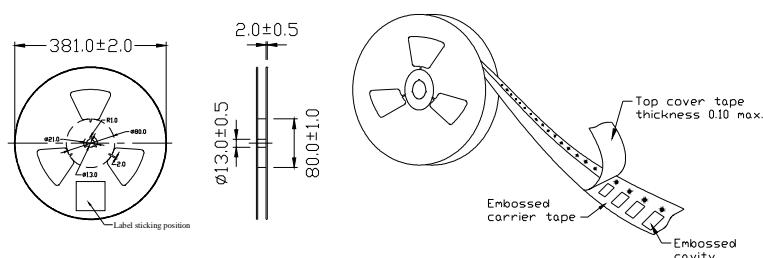

 YY=YEAR
WW=WEEK

 PC board pattern
(Top view)


Tape dimensions

Direction of feed →



Dimensions of tape reel



单击下面可查看定价，库存，交付和生命周期等信息

[>>SUPSiC\(国晶微\)](#)